POWERTIP TECH. CORP.

SPECIFICATIONS

CUSTOMER	:	PTC
SAMPLE CODE	:	SH480272T009-IHC01
MASS PRODUCTION CODE	:	PH480272T009-IHC01
SAMPLE VERSION	:	01
SPECIFICATIONS EDITION	:	003
DRAWING NO. (Ver.)	:	JLMD-PH480272T009-IHC01_002
PACKAGING NO. (Ver.)	:	JPKG-PH480272T009-IHC01_001

Customer Approved

Date:

Approved	Checked	Designer
閆偉	張久慧	劉進

□ Preliminary specification for design input

■ Specification for sample approval

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History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
08/04/2016	01	001	New Drawing	-	徐明菲
10/19/2016	01	002	Second Drawing	-	徐明菲
02/23/2016	01	003	New Sample Modify The Power Supply For FOG	5,6,14,17,19,20	劉進

Total: 31 Pages

Contents

1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	480 * 3 (RGB) * 272 Dots
LCD Type	a-Si TFT , Normally white, Transmissive type
Screen size(inch)	4.3 inch
Viewing Direction	6 O'clock
Color configuration	RGB-Strip
Interface	Digital 24-bits RGB
Other(controller/driver IC)	ILI6480B (Or Compatible IC)
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer website : http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	113.2(W) * 73.2 (L) * 3.95(H)	mm

LCD panel

Item	Standard Value	Unit
Active Area	95.04 (W) x 53.856 (L)	mm

Touch panel

Item	Standard Value	Unit
Viewing Area	97.1 (W) * 55.9 (L)	mm

Note : For detailed information please refer to LCM drawing.

1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	DV_{DD}	GND=0	-0.5	5.0	V
Operating Temperature	T_{OP}	-	-20	70	°C
Storage Temperature	T_{ST}	-	-30	80	°C
Storage Humidity	HD	Ta ≦ 60 °C	20	90	%RH

1.4 DC Electrical Characteristics

Module GND = 0V, Ta = 25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
System Power Supply Voltage	DV_{DD}	-	3.0	3.3	3.6	V
Input H/L Level Voltage	V_{IH}	-	0.7*DV_{DD}	-	DV_{DD}	V
	V_{IL}	-	0	-	0.3*DV_{DD}	V
Output H/L Level Voltage	V_{OH}	-	DV_{DD}-0.4	-	-	V
	V_{OL}	-	0	-	0.4	V
Supply Current	I_{DD}	DV_{DD} = 3.3 V	-	16	25	mA

1.5 Optical Characteristics

TFT LCD Module DV_{DD} = 3.3 V, Ta=25°C

Item		Symbol	Condition	Min.	Typ.	Max.	unit	-
Response time	Tr+Tf	25℃	-	-	29	44	ms	Note 2
Viewing angle	Top	θ+	CR ≥ 10	-	60	-	Deg.	Note 1
	Bottom	θ-		-	60	-		
	Left	θL		-	60	-		
	Right	θR		-	60	-		
Contrast ratio		CR	-	500	600	-	-	Note 3
Color of CIE Coordinate (BL & LCD & TP)	White	X	IF= 40 mA	0.24	0.29	0.34	-	Note4
		Y		0.26	0.31	0.36		
	Red	X		0.52	0.57	0.62		
		Y		0.28	0.33	0.38		
	Green	X		0.30	0.35	0.40		
		Y		0.56	0.61	0.66		
	Blue	X		0.10	0.15	0.20		
		Y		0.02	0.07	0.12		
Average Brightness Pattern=white display (BL & LCD & TP)*1		IV	IF= 40 mA	680	850	-	cd/m^2	
Uniformity (BL & LCD & TP)*2		△B	IF= 40 mA	70	-	-	%	

Note 4 ：

1：△B=B(min) / B(max) * 100%

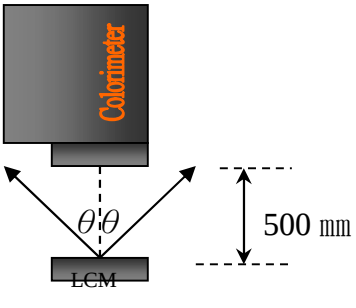
2：Measurement Condition for Optical Characteristics:

a：Environment: 25℃±5℃ / 60±20%R.H，no wind，dark room below 10 Lux at typical lamp current and typical operating frequency.

b：Measurement Distance: 500 ± 50 ㎜ ，(θ= 0°)

c：Equipment: TOPCON BM-7 fast，(field 1°)，after 10 minutes operation.

d：The uncertainty of the C.I.E coordinate measurement ±0.01，Average Brightness ± 4%

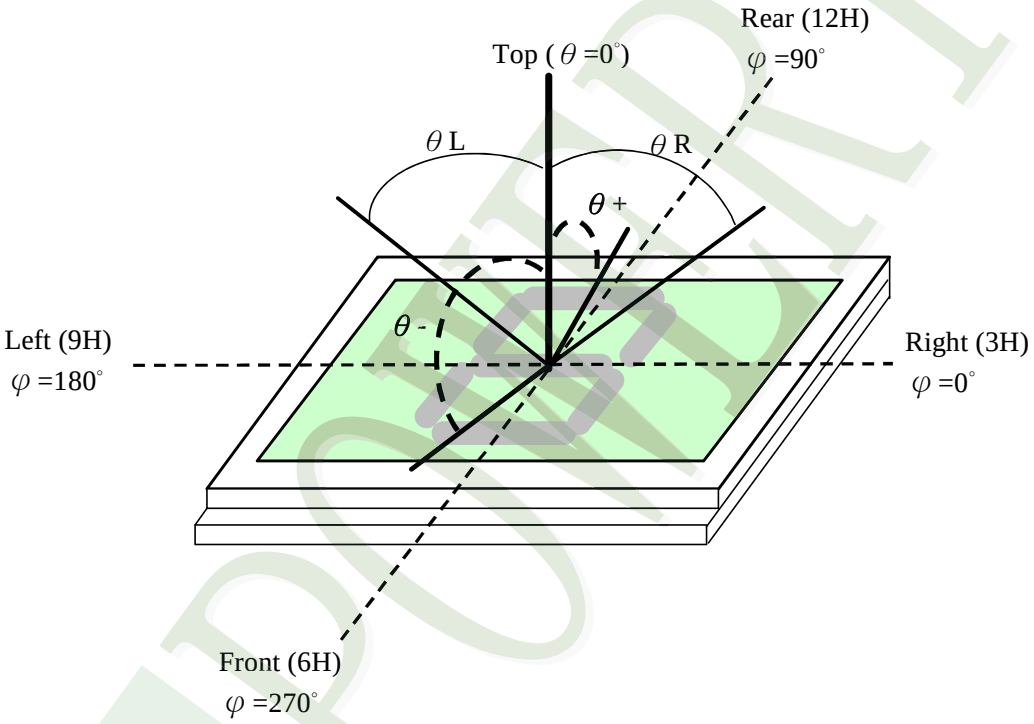


Colorimeter=BM-7 fast

Note 1.

Optical characteristics-2

Viewing angle

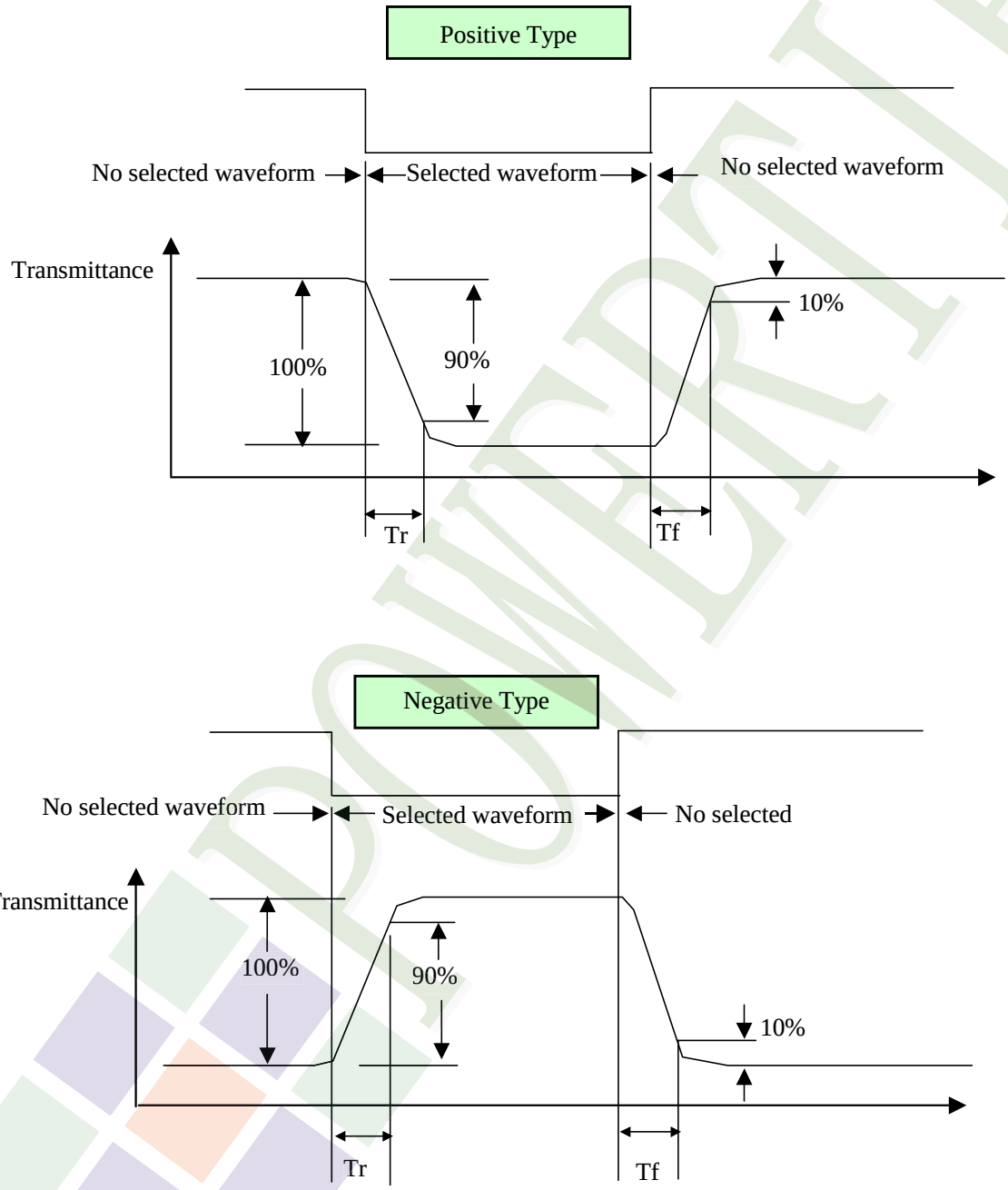


Viewing angle

Note 2.

Optical characteristics-3

Fig.2 Definition of response time



Electrical characteristics-2

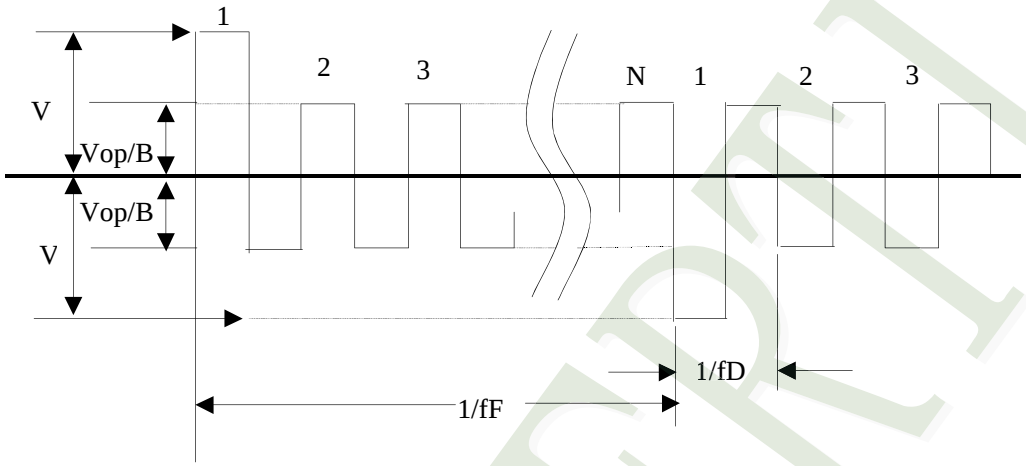
※2 Drive waveform

Vop: Drive voltage fF: Frame frequency

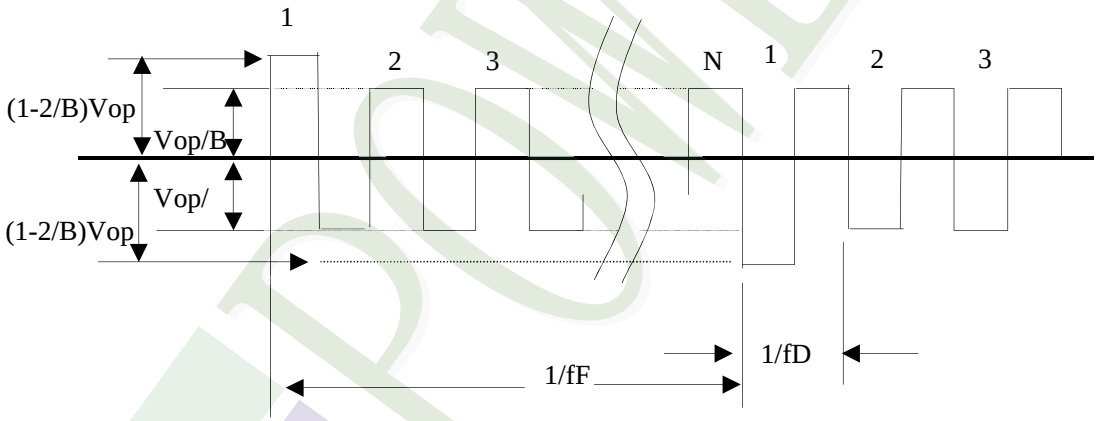
1/B: Bias fD: Drive frequency

N: Duty

(1) Selected waveform



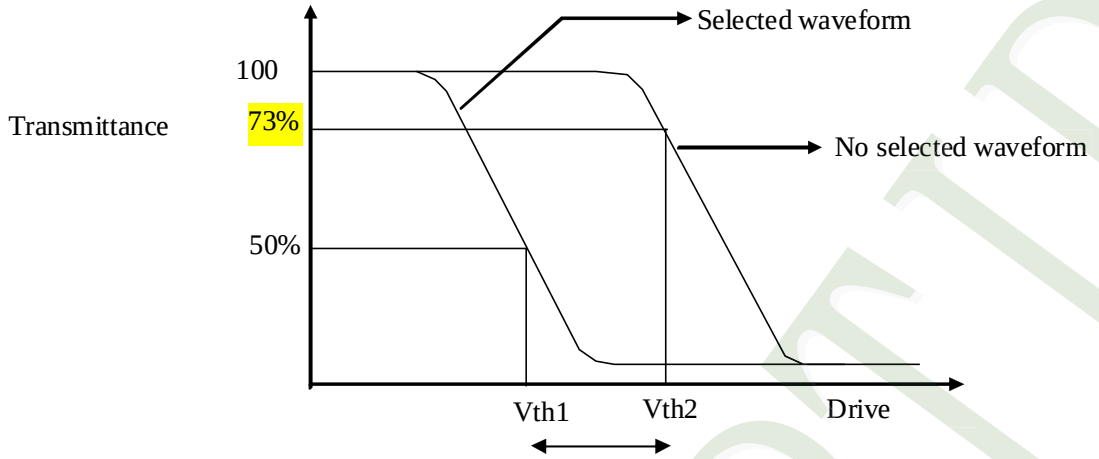
(2) Non- Selected wave form



Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period

Note 3. : Definition of Vth

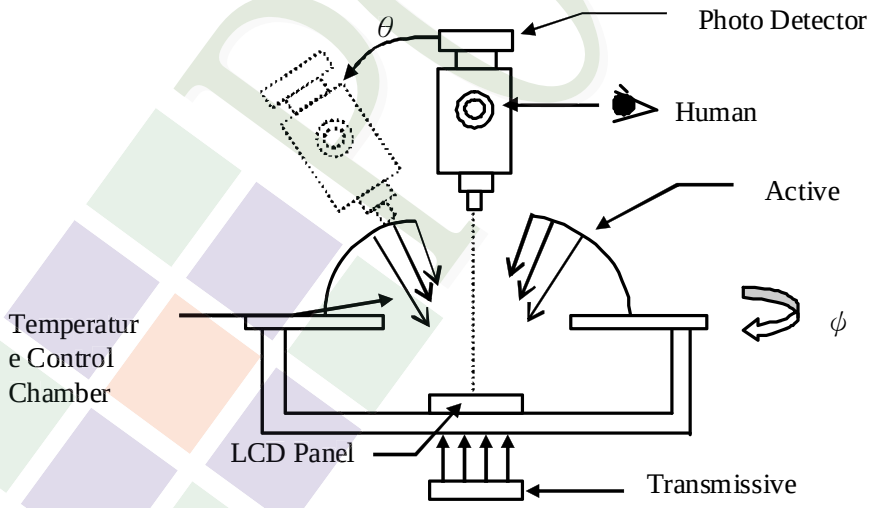


Active voltage range

	Vth1	Vth2
View direction	10°	40°
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

※1 Contrast ratio
= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System



Measuring System: Autronic DMS-803

1.6 Backlight Characteristics

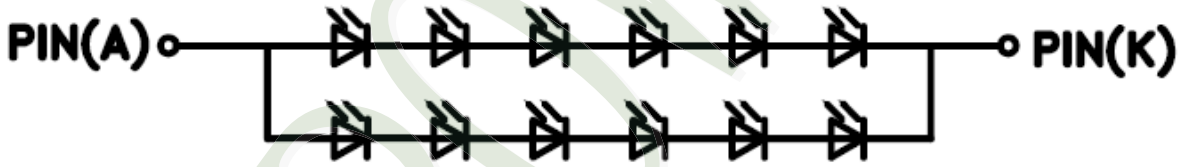
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current	IF	Ta =25℃	-	30*2	mA
LED Reverse Voltage	VR	Ta =25℃	-	5	V
Power Dissipation	PD	Ta =25℃	-	1224	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF= 40 mA	17.6	19.2	20.4	V
Average Brightness (Without LCD)	IV		9500	11000	-	cd/m^2
CIE Color Coordinate (Without LCD)	X		0.26	0.29	0.32	-
	Y		0.26	0.29	0.32	
Color	White					

Circuit diagram：



Other Description

Item	Conditions	Description
Life Time	Ta =25℃ IF= 40mA	(50000) hrs

1.7 Touch Panel Characteristics

Features

Item	Standard Value
Touch Panel Size	4.3”
Touch type	Projective capacitive touch panel
Input Method	Finger / 5 Points touch
Output Interface	I^2C
IC	ST1633

Mechanical Specifications

Item	Standard Value	Unit
Viewing Area	97.1 (W) * 55.9 (L)	mm
Number of sensing channel	18 * 10	

Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Supply voltage	TPVDD	-	-0.3	+6.0	V
Operating Temperature	T_{OP}	-	-20	+70	°C
Storage Temperature	T_{ST}	-	-30	+80	°C

DC Electrical Characteristics

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Power Supply Voltage	TPVDD	-	2.8	3.3	3.6	V
Input High Voltage	VIH	-	0.85*TPVDD	-	-	V
Input Low Voltage	VIL	-	-	-	0.15*TPVDD	V

Touch Panel IC Read/Write description & Register Mapping

Reference :Sitronix Touch Driver Porting Reference Guide.

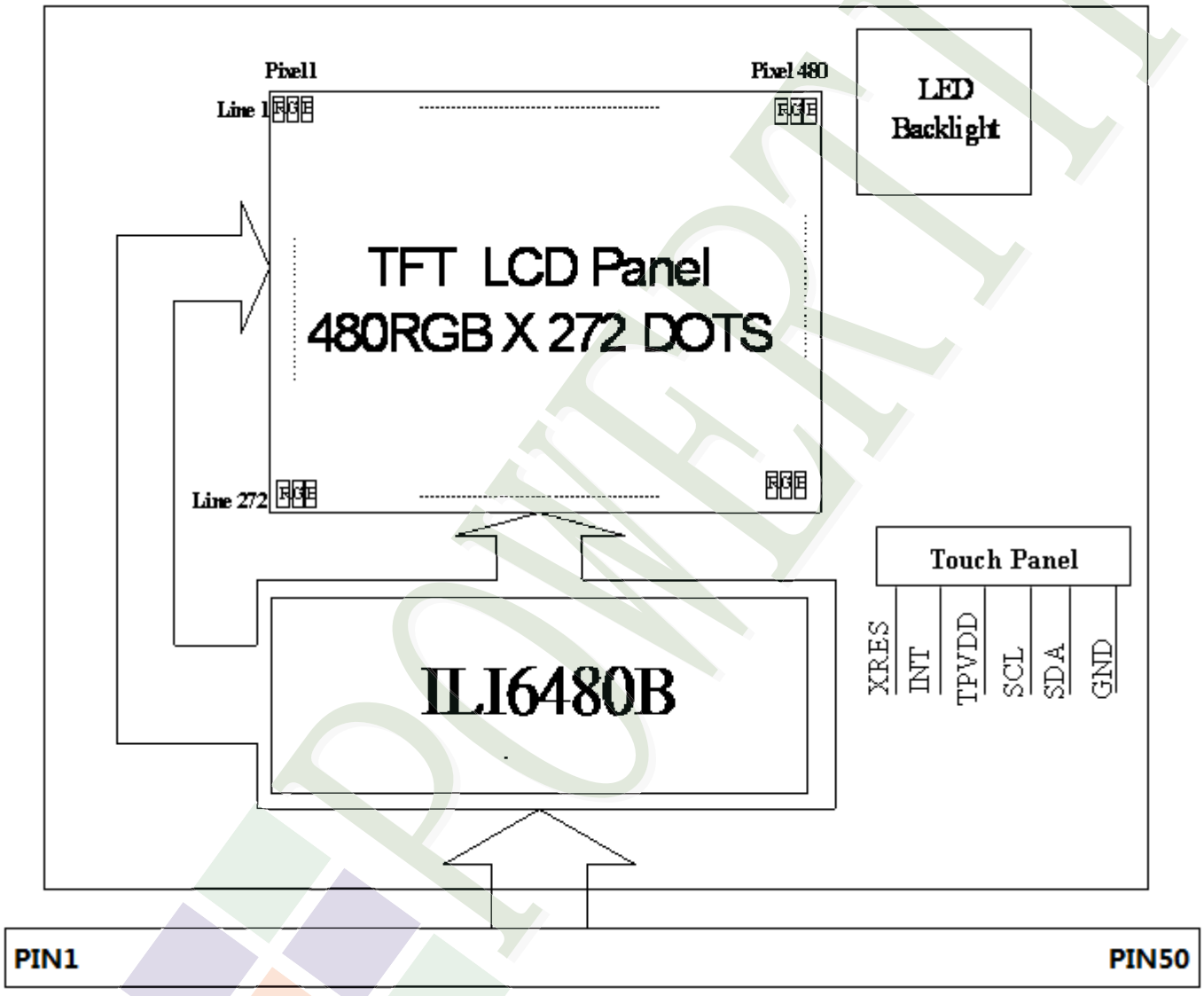
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram



2.2 Interface Pin Description

FOG Interface

Pin No.	Symbol	Function
1	V_{LED+}	Power For LED backlight (+).
2	V_{LED+}	Power For LED backlight (+).
3	V_{LED-}	Power For LED backlight (-).
4	V_{LED-}	Power For LED backlight (-).
5	GND	Power ground.
6	NC	No connection.
7	DV_{DD}	Power for Digital Circuit, analog circuits & logic I/O.(Power Supply for FOG)
8	NC	No connection.
9	DEN	Data input Enable. Active High to enable the data input Bus under “DE Mode”.
10	VS	Vertical Sync input. Negative polarity.
11	HS	Horizontal Sync input. Negative polarity.
12	B7	Blue Data (MSB).
13	B6	Blue Data.
14	B5	Blue Data.
15	B4	Blue Data.
16	B3	Blue Data.
17	B2	Blue Data.
18	B1	Blue Data.
19	B0	Blue Data (LSB).
20	G7	Green Data (MSB).
21	G6	Green Data.
22	G5	Green Data.
23	G4	Green Data.
24	G3	Green Data.
25	G2	Green Data.
26	G1	Green Data.
27	G0	Green Data (LSB).

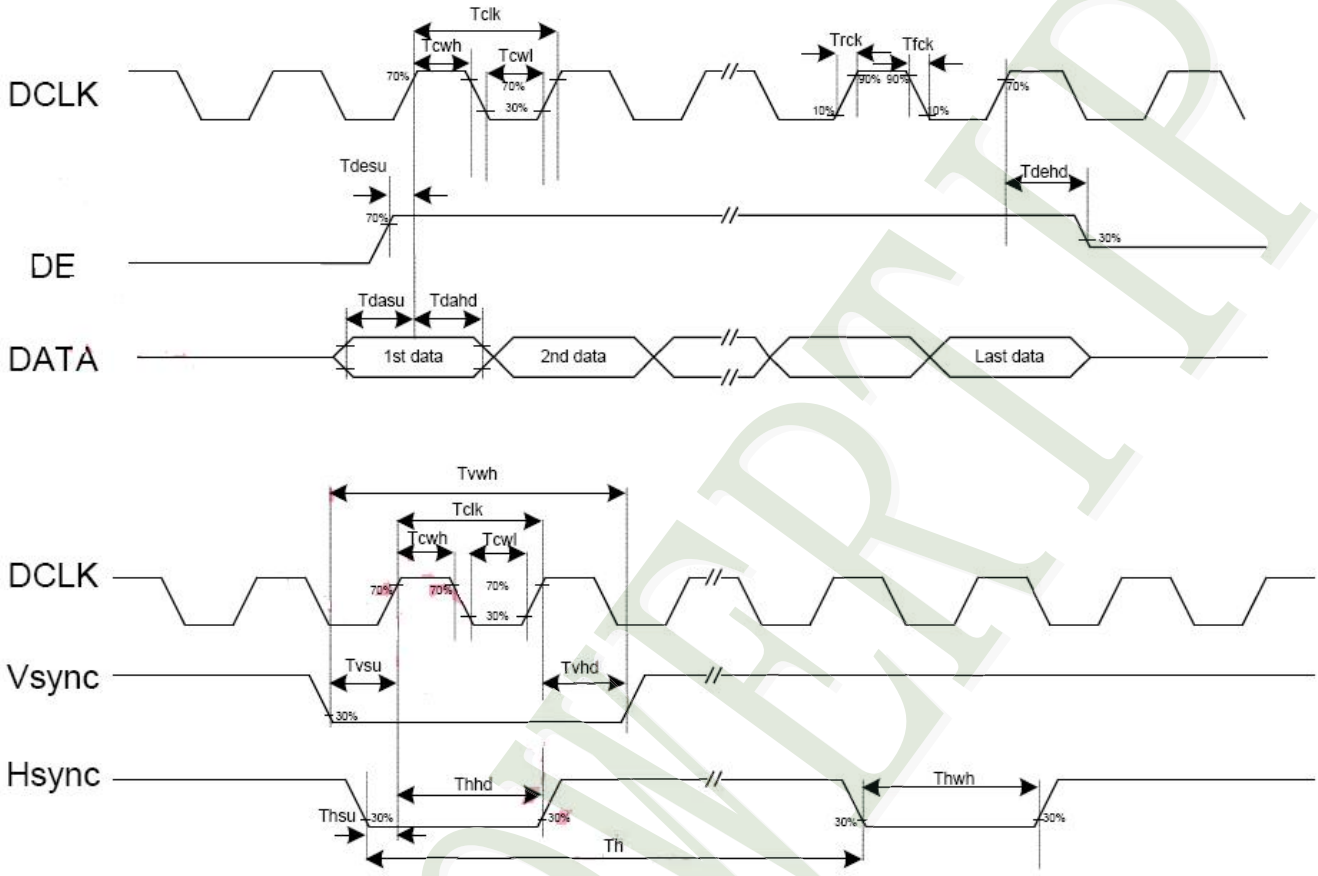
Pin No.	Symbol	Function
28	R7	Red Data (MSB).
29	R6	Red Data.
30	R5	Red Data.
31	R4	Red Data.
32	R3	Red Data.
33	R2	Red Data.
34	R1	Red Data.
35	R0	Red Data (LSB).
36	GND	Power Ground
37	DCLK	Clock signal. Latching data at the rising edge
38	GND	Power Ground.
39	NC	No connection.
40	NC	No connection.
41	NC	No connection.
42	NC	No connection.
43	NC	No connection.
44	RESETB	Active low global reset signal input.
45	NC	No connection.
46	NC	No connection.
47	NC	No connection.
48	GND	Power Ground.
49	NC	No connection.
50	NC	No connection.

Capacitive Touch Panel (CTP) Interface

Pin No.	Symbol	Function
1	GND	Ground.
2	TPVDD	Power Supply for CTP.
3	SCL	I^2C Clock.
4	SDA	I^2C Data.
5	INT	The interrupt from the CTP to the Host.
6	RESET	RESET.

2.3 Timing Characteristics

2.3.1 Clock and Data Input Waveforms



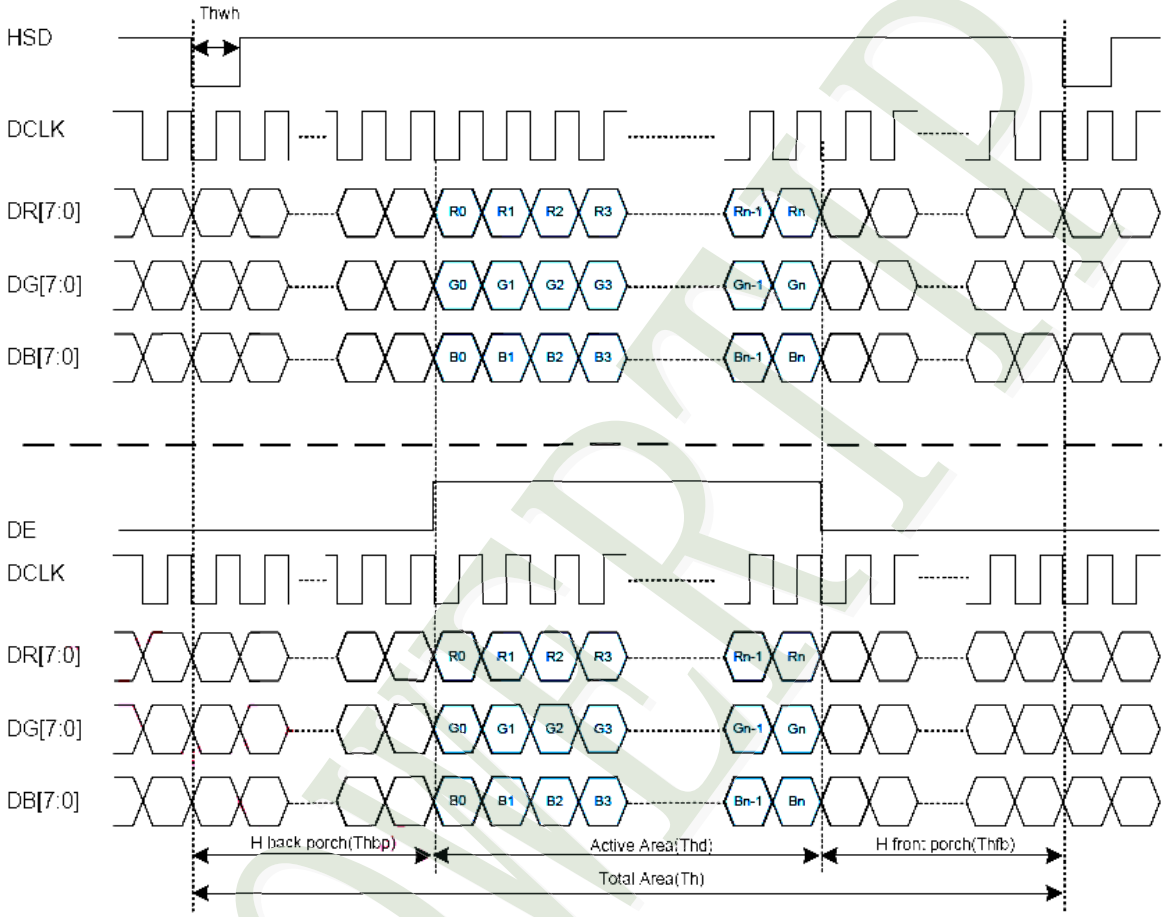
AC Electrical Characteristics (DV_{DD}=3.0 to 3.6v, GND=0V, TA=-20 to +85 ℃)

Parameters	Symbol	Min.	Typ.	Max.	Unit	Conditions
System operation timing						
DV_{DD} power source slew time	TPOR	-	-	20	ms	From 0V to 99% DV_{DD}
GRB pulse width	tRSTW	10	50	-	us	R=10Kohm, C=1uF
Input Output timing						
DCLK clock time	Tclk	33.3	-	-	ns	DCLK=30MHz
DCLK clock low period	Tcwl	40	-	60	%	
DCLK clock high period	Tcwh	40	-	60	%	
Clock rising time	Trck	9	-	-	ns	
Clock falling time	Tfck	9	-	-	ns	
HSD width	Thwh	1	-	-	DCLK	
HSD period time	Th	55	60	65	us	
HSD setup time	Thsu	12	-	-	ns	
HSD hold time	Thhd	12	-	-	ns	
VSD width	Tvwh	1	-	-	Th	
VSD setup time	Tvsu	12	-	-	ns	
VSD hold time	Tvhd	12	-	-	ns	
Data setup time	Tdasu	12	-	-	ns	
Data hold time	Tdahd	12	-	-	ns	
DE setup time	Tdesu	12	-	-	ns	
DE hold time	Tdehd	12	-	-	ns	
Source output setting time	Tsst	-	-	TBD	us	10% to 90% CL=60pF, RL=2Kohm
Gate output setting time	Tgst	-	-	TBD	ns	10% to 90%, CL=60pF
VCOM output setting time	Tcst	-	-	TBD	us	10% to 90%, CL=40nF, RL=50ohm
Time from VSD to 1st line data input	Tvs	3	8	31	Th	HV mode By HDL[4:0] setting
3-wire serial communication AC timing						
Serial clock	Tsck	200	-	-	ns	For SCL pin
SCL pulse low period	Tckl	40	-	60	%	
SCL pulse low period	Tckh	40	-	60	%	
Serial data setup time	Tisu	50	-	-	ns	
Serial data hold time	Tihd	50	-	-	ns	
Serial clock high/low	Tssw	50	-	-	ns	
CSB to VSD	Tcv	1			us	
CSB distinguish time	Tcd	400	-	-	ns	
CSB input setup time	Tcsu	50	-	-	ns	
CSB input hold time	Tchd	50	-	-	ns	

2.4 Data Format

2.4.1 Parallel RGB Input Timing Diagram

(HV Mode)



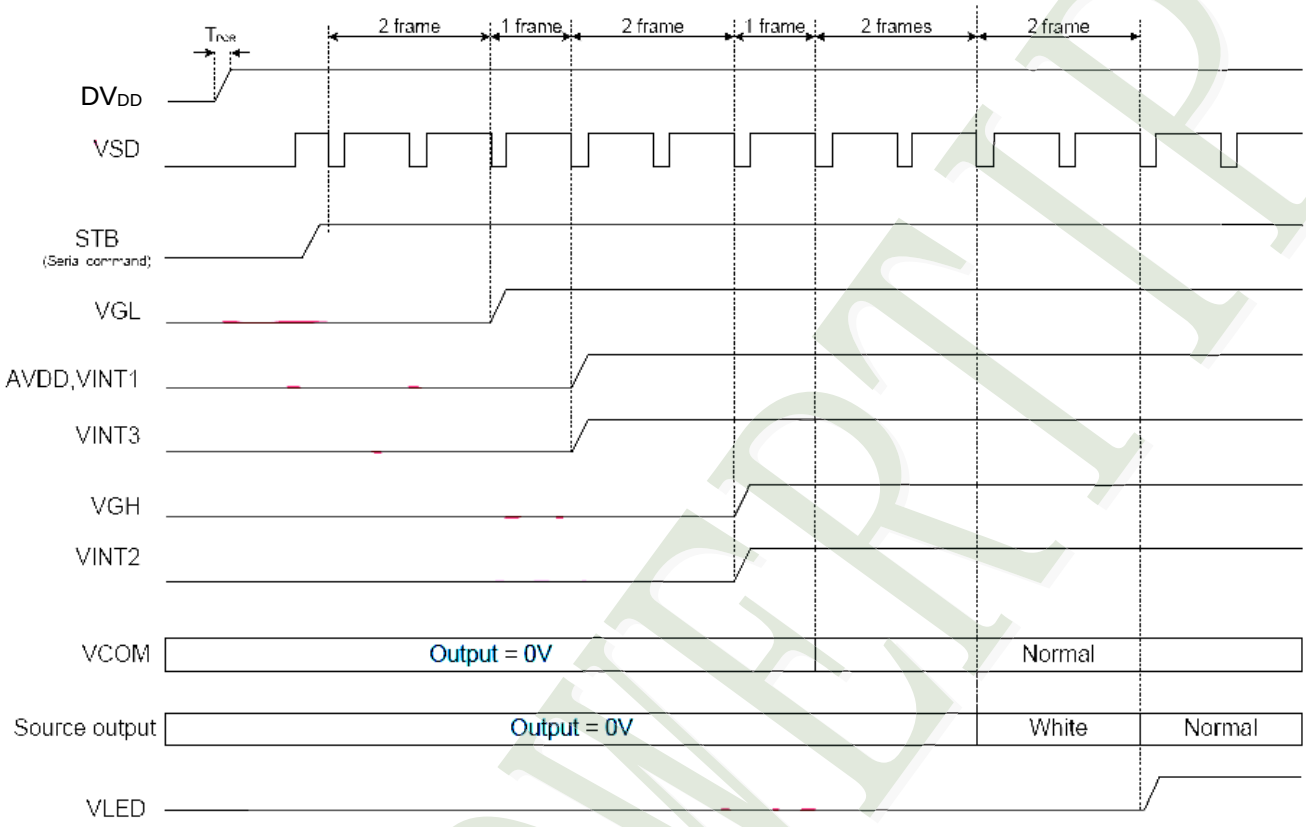
(DE Mode)

2.4.2 Parallel RGB Input Timing Table

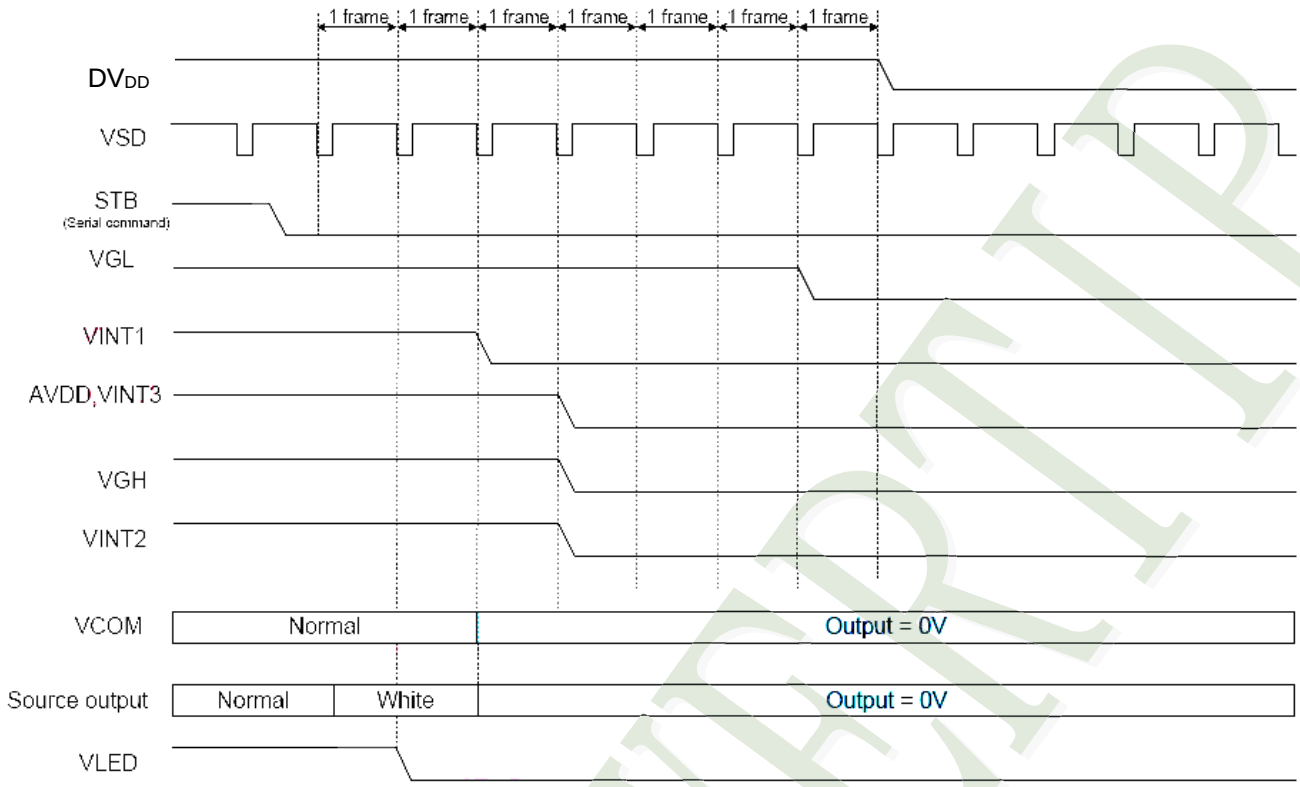
Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
DCLK frequency	fclk	5	9	12	MHz
VSD period time	Tv	277	288	400	H
VSD display area	Tvd		272		H
VSD back porch	Tvb	3	8	31	H
VSD front porch	Tvfp	2	8	97	H
HSD period time	Th	520	525	800	DCLK
HSD display area	Thd		480		DCLK
HSD back porch	Thbp	36	40	255	DCLK
HSD front porch	Thfp	4	5	65	DCLK

2.5 Power On/Off Sequence

2.5.1 Power On Sequence

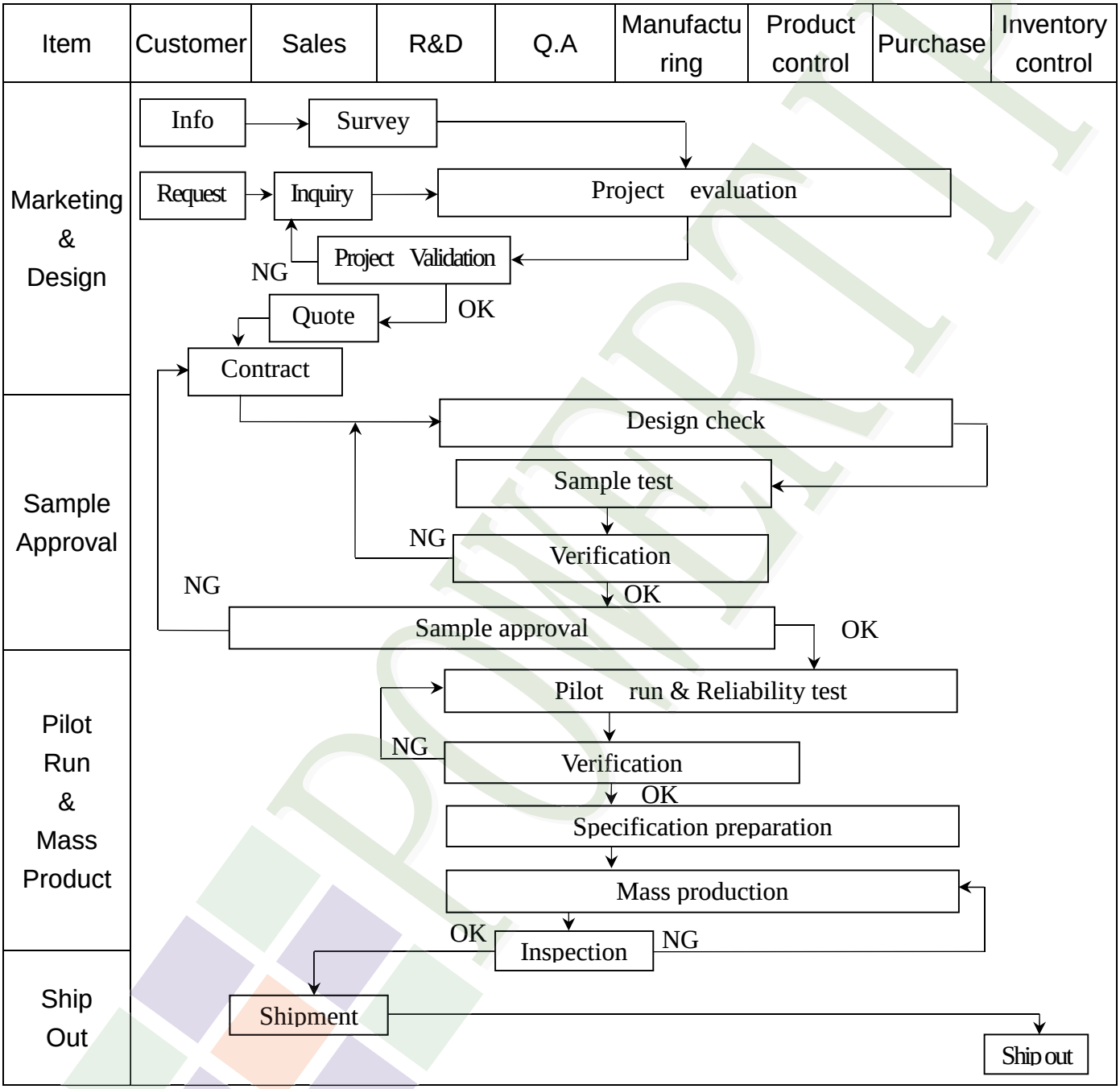


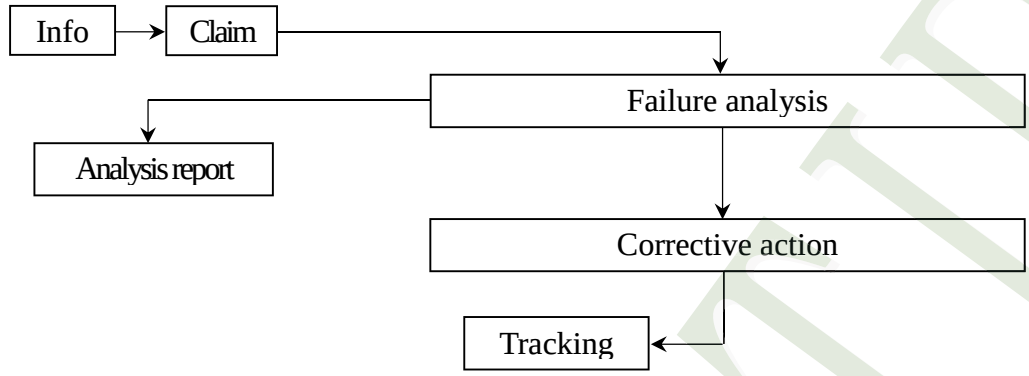
2.5.2 Power Off Sequence



3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



Item	Customer	Sales	R&D	Q.A	Manufacturing	Product control	Purchase	Inventory control
Sales Service								
Q.A Activity	1. ISO 9001 Maintenance Activities 2. Process improvement proposal 3. Equipment calibration 4. Education And Training Activities 5. Standardization Management							

3.2 Inspection Specification

◆Scope：The document shall be applied to TFT-LCD Module for 3.5″ ~10″ (Ver:B01).

◆Inspection Standard：MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment：Gauge、MIL-STD、Powertip Tester、Sample

◆Defect Level：Major Defect AQL： 0.4 ； Minor Defect AQL： 1.5

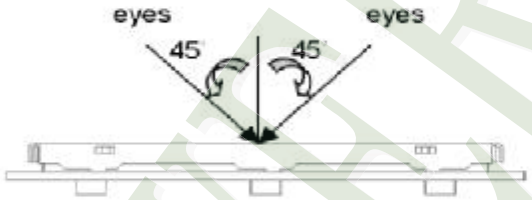
◆OUT Going Defect Level：Sampling.

◆Standard of the product appearance test：

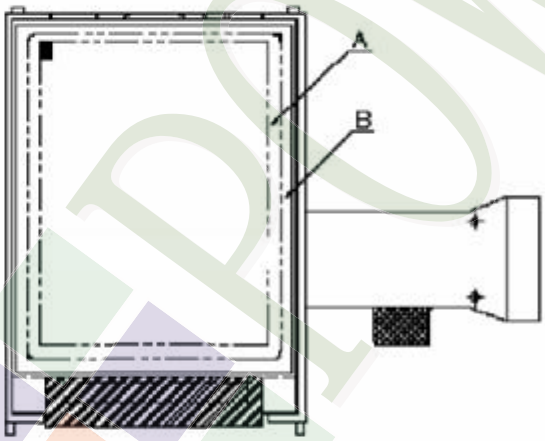
a. Manner of appearance test：

(1). The test best be under 20W×2 fluorescent light，and distance of view must be at 30 cm.

(2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area : viewing area

B area : Outside of viewing area

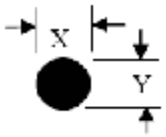
(4). Standard of inspection： (Unit：mm)

◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver.B01)

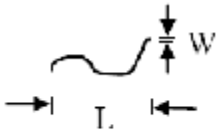
<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td rowspan="3">01</td><td rowspan="3">Product condition</td><td>1.1 The part number is inconsistent with work order of production.</td><td>Major</td></tr>
<tr><td>1.2 Mixed product types.</td><td>Major</td></tr>
<tr><td>1.3 Assembled in inverse direction.</td><td>Major</td></tr>
<tr><td>02</td><td>Quantity</td><td>2.1 The quantity is inconsistent with work order of production.</td><td>Major</td></tr>
<tr><td>03</td><td>Outline dimension</td><td>3.1 Product dimension and structure must conform to structure diagram.</td><td>Major</td></tr>
<tr><td rowspan="5">04</td><td rowspan="5">Electrical Testing</td><td>4.1 Missing line character and icon.</td><td>Major</td></tr>
<tr><td>4.2 No function or no display.</td><td>Major</td></tr>
<tr><td>4.3 Display malfunction.</td><td>Major</td></tr>
<tr><td>4.4 LCD viewing angle defect.</td><td>Major</td></tr>
<tr><td>4.5 Current consumption exceeds product specifications.</td><td>Major</td></tr>
<tr><td>05</td><td>Dot defect
(Bright dot、Dark dot)
On -display</td><td>
<table>
<tr><th colspan="2">Item</th><th>Acceptance (Q'ty)</th></tr>
<tr><td rowspan="4">Dot Defect</td><td>Bright Dot</td><td>≦ 4</td></tr>
<tr><td>Dark Dot</td><td>≦ 5</td></tr>
<tr><td>Joint Dot</td><td>≦ 3</td></tr>
<tr><td>Total</td><td>≦ 7</td></tr>
</table>
5.1 Inspection pattern：full white , full black , Red , Green and blue screens.
5.2 It is defined as dot defect if defect area ＞1/2 dot.
5.3 The distance between two dot defect ≧5 mm.
</td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver.B01)

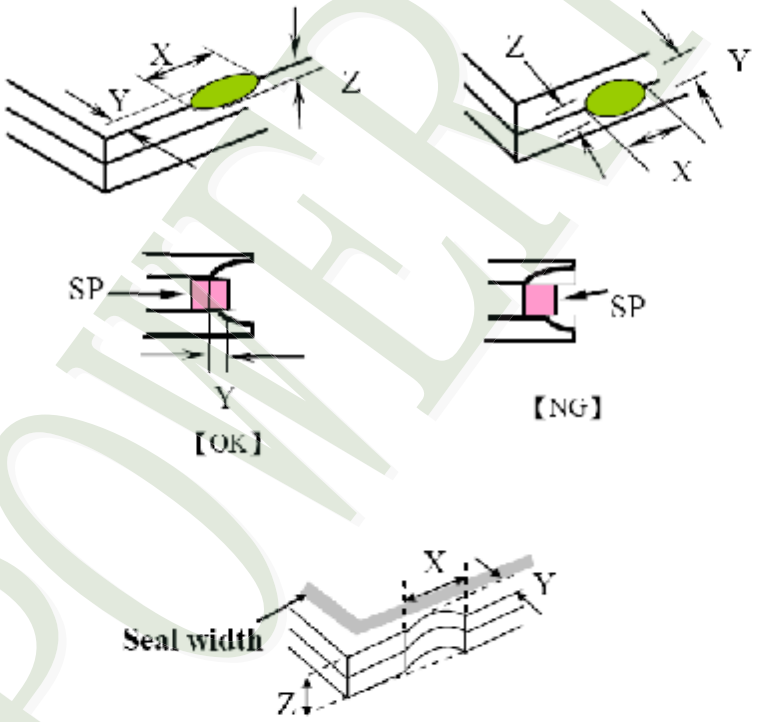
<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td>06</td><td>Black or white dot、scratch、contamination

Round type
 

Φ=(x+y) / 2

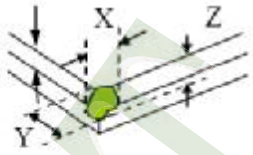
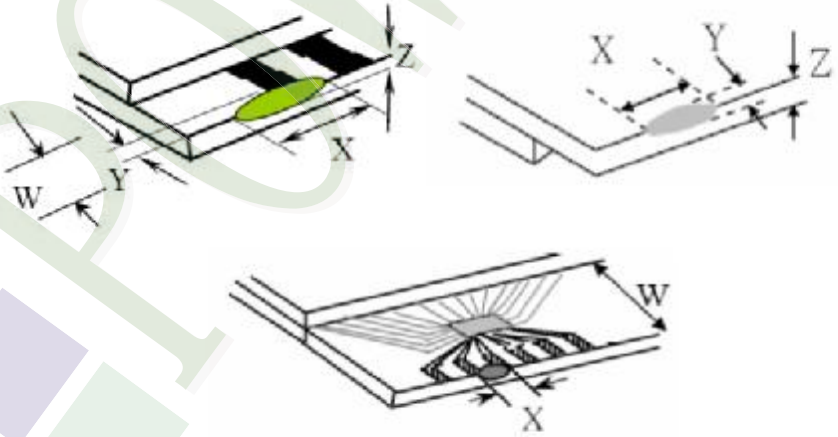
Line type
 
</td><td>6.1 Round type (Non-display or display) :
<table><tr><th rowspan="2">Dimension (diameter : Φ)</th><th colspan="2">Acceptance (Q'ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td>Φ ≦ 0.25</td><td>Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>0.25 < Φ ≦ 0.50</td><td>5</td></tr><tr><td>Φ > 0.50</td><td>0</td></tr><tr><td>Total</td><td>5</td></tr></table>
6.2 Line type(Non-display or display) :
<table><tr><th rowspan="2">Length (L)</th><th rowspan="2">Width (W)</th><th colspan="2">Acceptance (Q'ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td>---</td><td>W ≦ 0.03</td><td>Ignore</td><td rowspan="5">Ignore</td></tr><tr><td>L ≦10.0</td><td>0.03 < W ≦ 0.05</td><td>4</td></tr><tr><td>L ≦5.0</td><td>0.05 < W ≦ 0.10</td><td>2</td></tr><tr><td>---</td><td>W >0.10</td><td>As round type</td></tr><tr><td colspan="2">Total</td><td>5</td></tr></table></td><td>Minor</td></tr>
<tr><td>07</td><td>Polarizer Bubble</td><td><table><tr><th rowspan="2">Dimension (diameter : Φ)</th><th colspan="2">Acceptance (Q'ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td>Φ ≦ 0.25</td><td>Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>0.25 < Φ ≦ 0.50</td><td>4</td></tr><tr><td>0.50 < Φ ≦ 0.80</td><td>1</td></tr><tr><td>Φ > 0.80</td><td>0</td></tr><tr><td>Total</td><td>5</td></tr></table></td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver:B01)

NO	Item	Criterion	Level
08	The crack of glass	Symbols : X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length 8.1 General glass chip : 8.1.1 Chip on panel surface and crack between panels: 	Minor

X	Y	Z
≦ a	Crack can't enter viewing area	≤1/2 t
≦ a	Crack can't exceed the half of SP width.	1/2 t < Z ≦2 t

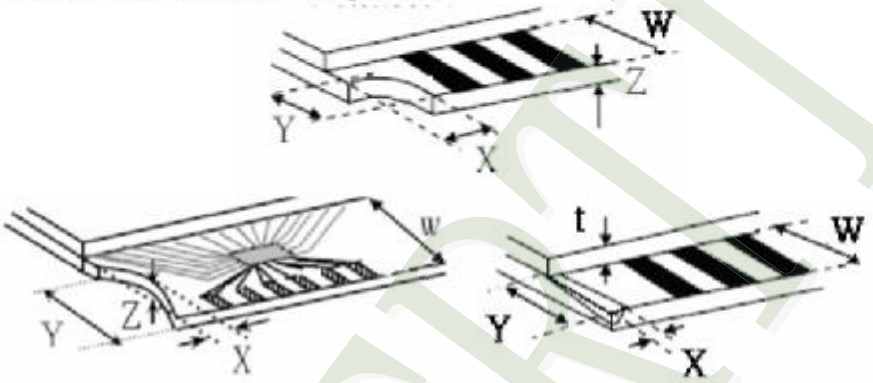
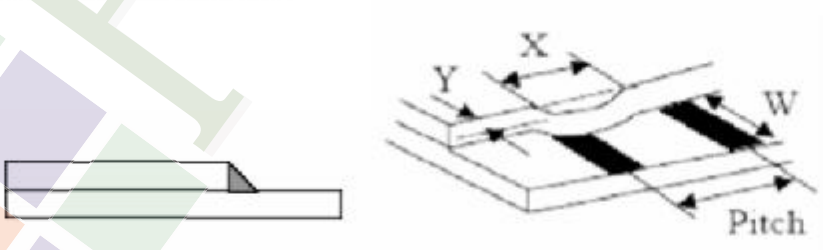
◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver.B01)

NO	Item	Criterion	Level
08	The crack of glass	Symbols : X : The length of crack Z : The thickness of crack t : The thickness of glass Y : The width of crack. W : terminal length a : LCD side length 8.1.2 Corner crack : 	
		8.2 Protrusion over terminal : 8.2.1 Chip on electrode pad : 	Minor

X	Y	Z
≦1/5 a	Crack can't enter viewing area	Z ≦ 1/2 t
≦1/5 a	Crack can't exceed the half of SP width.	1/2 t < Z ≦ 2 t

	X	Y	Z
Front	≦ a	≦ 1/2 W	≦ t
Back	≦ a	≦ W	≦ 1/2 t

◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver.B01)

NO	Item	Criterion	Level
08	The crack of glass	Symbols : X : The length of crack　Y : The width of crack. Z : The thickness of crack　W : terminal length t : The thickness of glass　a : LCD side length 8.2.2 Non-conductive portion :  X ≦ 1/3 a　Y ≦ W　Z ≦ t ⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. 8.2.3 Glass remain :  X ≦ a　Y ≦ 1/3 W　Z ≦ t	Minor

◆Specification For TFT-LCD Module 3.5″ ~10″ : (Ver.B01)

NO	Item	Criterion	Level
09	Backlight elements	9.1 Backlight can't work normally.	Major
		9.2 Backlight doesn't light or color is wrong.	Major
		9.3 Illumination source flickers when lit.	Major
10	General appearance	10.1 Pin type、quantity、dimension must match type in structure diagram.	Major
		10.2 No short circuits in components on PCB or FPC .	Major
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
		10.4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
		10.6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≦1.5 mm.	Minor

4. RELIABILITY TEST

4.1 Reliability Test Condition (Ver.B01)

<table>
<tr><th>NO.</th><th>TEST ITEM</th><th>TEST CONDITION</th></tr>
<tr><td>1</td><td>High Temperature Storage Test</td><td>Keep in +80 ±2℃ 96 hrs
Surrounding temperature, then storage at normal condition 4hrs.</td></tr>
<tr><td>2</td><td>Low Temperature Storage Test</td><td>Keep in -30 ±2℃ 96 hrs
Surrounding temperature, then storage at normal condition 4hrs.</td></tr>
<tr><td>3</td><td>High Temperature / High Humidity Storage Test</td><td>Keep in +60 ℃ / 90% R.H duration for 96 hrs
Surrounding temperature, then storage at normal condition 4hrs.
(Excluding the polarizer)</td></tr>
<tr><td>4</td><td>Temperature Cycling Storage Test</td><td>-30℃ → +25℃ → +80℃ → +25℃
(30mins) (5mins) (30mins) (5mins)
10 Cycle
Surrounding temperature, then storage at normal condition 4hrs.</td></tr>
<tr><td rowspan="2">5</td><td rowspan="2">ESD Test</td><td>Air Discharge:
Apply 2 KV with 5 times
Discharge for each polarity +/-</td><td>Contact Discharge:
Apply 250 V with 5 times
discharge for each polarity +/-</td></tr>
<tr><td colspan="2">1. Temperature ambiance : 15℃～35℃
2. Humidity relative : 30%～60%
3. Energy Storage Capacitance(Cs+Cd) : 150pF±10%
4. Discharge Resistance(Rd) : 330Ω±10%
5. Discharge, mode of operation :
Single Discharge (time between successive discharges at least 1 sec)
(Tolerance if the output voltage indication : ±5%)</td></tr>
<tr><td>6</td><td>Vibration Test (Packaged)</td><td colspan="2">1. Sine wave 10～55 Hz frequency (1 min/sweep)
2. The amplitude of vibration :1.5 mm
3. Each direction (X、Y、Z) duration for 2 Hrs</td></tr>
<tr><td>7</td><td>Drop Test (Packaged)</td><td colspan="2">
<table>
<tr><th>Packing Weight (Kg)</th><th>Drop Height (cm)</th></tr>
<tr><td>0 ~ 45.4</td><td>122</td></tr>
<tr><td>45.4 ~ 90.8</td><td>76</td></tr>
<tr><td>90.8 ~ 454</td><td>61</td></tr>
<tr><td>Over 454</td><td>46</td></tr>
</table>
Drop Direction :※1 corner / 3 edges / 6 sides each 1time
</td></tr>
</table>

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.

5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

5.2.1 Avoid any strong mechanical shock which can break the glass.

5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.

5.2.3 Do not remove the panel or frame from the module.

5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)

5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.

5.2.6 Do not touch the display area with bare hands , this will stain the display area.

5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.2.8 To control temperature and time of soldering is 320±10℃and 3-5 sec.

5.2.9 To avoid liquid (include organic solvent) stained on LCM .

5.3 STORAGE

5.3.1 Store the panel or module in a dark place where the temperature is 25℃ ±5℃ and the humidity is below 65% RH.

5.3.2 Do not place the module near organics solvents or corrosive gases.

5.3.3 Do not crush , shake , or jolt the module.

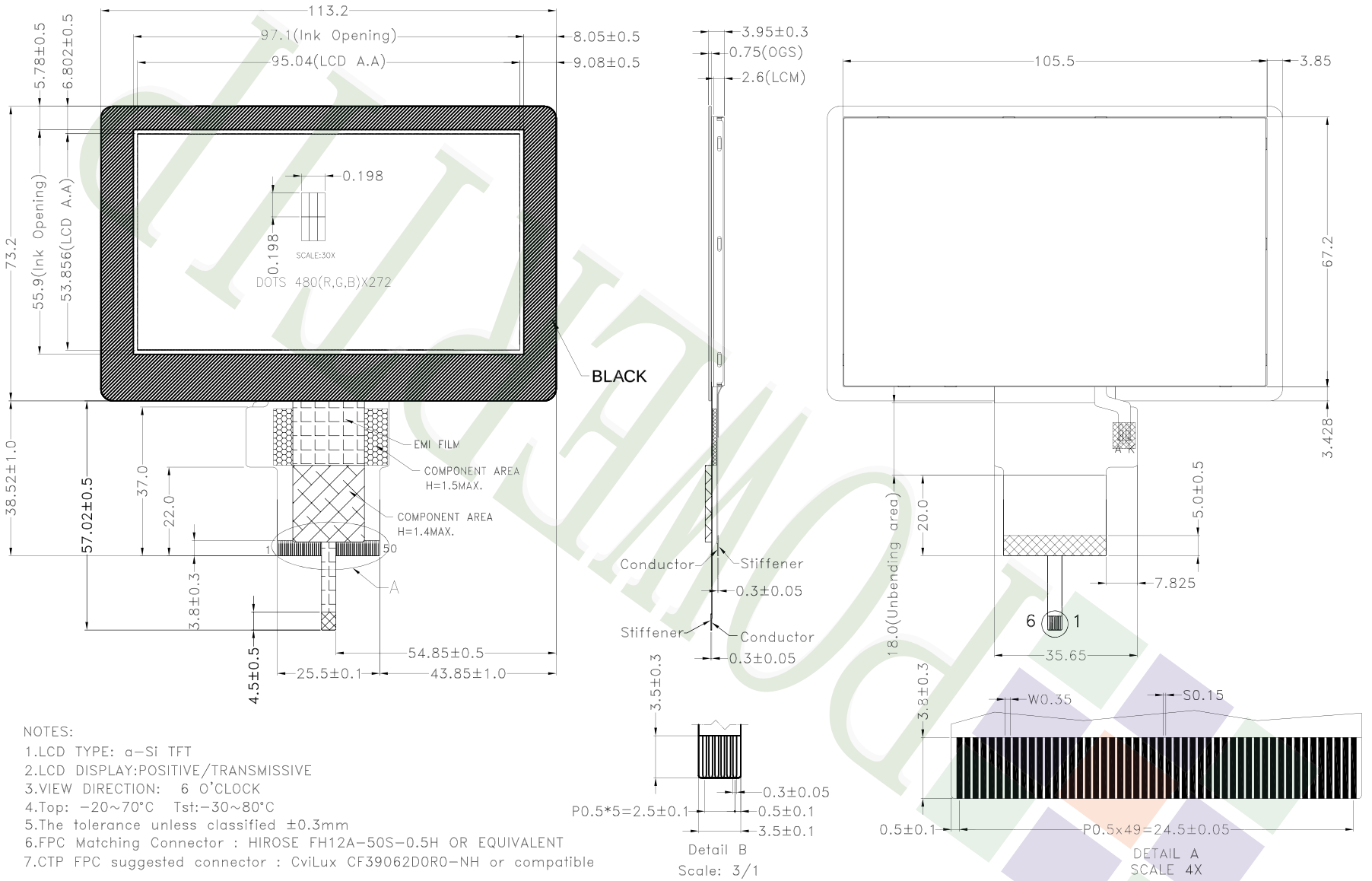
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment , we cannot take responsibility if the product is used in nuclear power control equipment , aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



NOTES:
1.LCD TYPE: a-Si TFT
2.LCD DISPLAY:POSITIVE/TRANSMISSIVE
3.VIEW DIRECTION: 6 O'CLOCK
4.Top: -20~70°C Tst:-30~80°C
5.The tolerance unless classified ±0.3mm
6.FPC Matching Connector : HIROSE FH12A-50S-0.5H OR EQUIVALENT
7.CTP FPC suggested connector : CviLux CF39062D0R0-NH or compatible

REV	REV BY	REVISER	DATE
007			
006			
005			
004			
003			
002	CHANGE T/P	Air	2016/10/19
001	NEW DRAWING	Air	2016/08/04

PART NO: PH480272T009-IHC01
DRAWING NAME : JLMD-PH480272T009-IHC01
TITLE: LCD Module Drawing

久正光電股份有限公司
POWERTIP TECHNOLOGY CORPORATION

Design	Air	(3)	Surface		
Check	Terry	Unit	MM	Material	
		Scale	FIT	Thickness	
Approve	Ryan	Page	1/1	Quantity	

Precision / Tolerance / Length(Min) (mm)	Precision Level
1 ~ 4	-
4 ~ 16	-
16 ~ 63	-
63 ~ 250	-
250 ~ 1000	-

Ver.001

Documents NO.	JPKG-PH480272T009-IHC01

LCM包裝規格書
LCM Packaging Specifications (For Tray)

Approve	Check	Contact
Ryan	Terry	Air

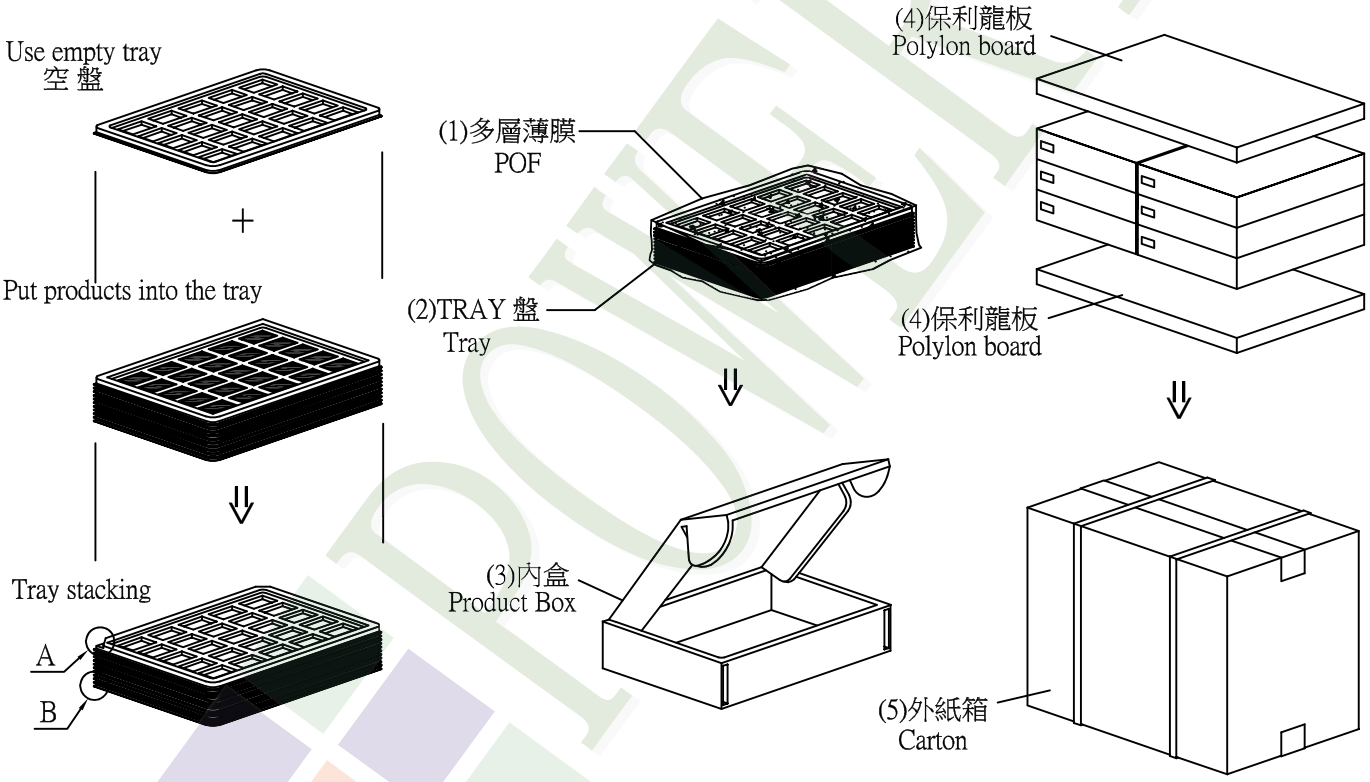
1.包裝材料規格表 (Packaging Material) : (per carton)

No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)	PH480272T009-IHC01	113.2X73.2X3.95	0.0568	144	8.1792
2	多層薄膜(1)POF	OTFILM0BA03ABA	19"X350X0.015	——	6	——
3	TRAY 盤 (2)Tray	TY00000000384	352 X 260 X 12.6	0.1	42	4.2
4	內盒(3)Product Box	BX36627063ABBA	383 X 270 X 66	0.182	6	1.092
5	保利龍板(4)Polylon board	OTPLB00PL08ABA	550 X 393 X 20	0.0284	2	0.0568
6	外紙箱(5)Carton	BX57041027CCBA	570 X 410 X 265	1.0	1	1.0
7						
8						
9						

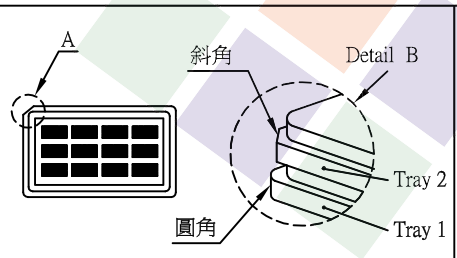
2.一 整箱總重量 (Total LCD Weight in carton) : 14.53 Kg±10%

3.單箱數量規格表 (Packaging Specifications and Quantity) :

(1)LCM quantity per box : no per tray	4	x no of tray	6	=	24
(2)Total LCM quantity in carton : quantity per box	24	x no of boxes	6	=	144



特 記 事 項 (REMARK)



4.TRAY盤相疊時,需旋轉180度,請詳見B視圖
Rotate tray 180 degrees and place on top of stack.
Check the tray stack using Fig. B.